

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE0102E uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} = 100V,I_D = 2A

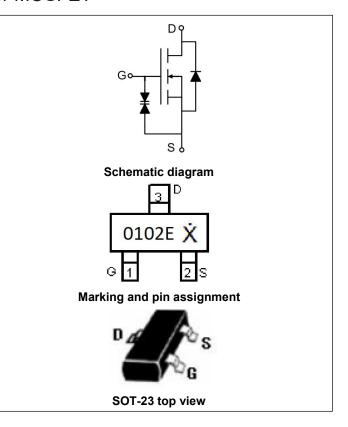
 $R_{\text{DS(ON)}}\,{<}210\text{m}\Omega\;\textcircled{0}\;V_{\text{GS}}{=}10V\quad\text{(Typ:}180\text{m}\Omega\text{)}$

 $R_{DS(ON)}$ <230m Ω @ V_{GS} =4.5V (Typ:190m Ω)

- High power and current handing capability
- Lead free product is acquired
- Surface mount package
- ESD Rating: HBM ≥1500V

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
0102 E	NCE0102E	SOT-23			

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	2	Α
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	1.4	А
Drain Current-Pulsed (Note 1)	I _{DM}	8	А
Maximum Power Dissipation	P _D	1.25	W
Avalanche Current (Note 1)	I _{AR}	2	А
Single pulse avalanche energy (Note 5)	Eas	6.25	mJ
Reverse diode dv/dt, V _{DS} ≤80 V, I _{SD} <i<sub>D</i<sub>	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic



http://www.ncepower.com

NCE0102E

Thermal Resistance, Junction-to-Ambient (Note 2)	R _{0JA}	100	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

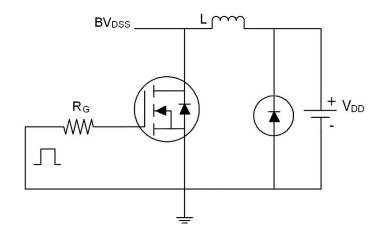
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics				•		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100	110	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	1.2	2	2.5	V
D : 0		V _{GS} =10V, I _D =2A	-	180	210	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =2A	-	190	230	mΩ
Forward Transconductance	g FS	V _{DS} =10V,I _D =2A	-	2	-	S
Dynamic Characteristics (Note4)	1					
Input Capacitance	Clss	.,	-	410.5	-	PF
Output Capacitance	Coss	$V_{DS}=50V, V_{GS}=0V,$	-	17.1	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	13.9	-	PF
Switching Characteristics (Note 4)	1		•	'		
Turn-on Delay Time	t _{d(on)}		-	6	-	nS
Turn-on Rise Time	t _r	V_{DD} =50V, R_L =25 Ω	-	10	-	nS
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =10 V , R_{G} =1 Ω	-	12	-	nS
Turn-Off Fall Time	t _f		-	8	-	nS
Total Gate Charge	Qg		-	13.8		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=50V,I_{D}=2A,$	-	2.1	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	2.9	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =2A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		_	-	2	Α

Notes:

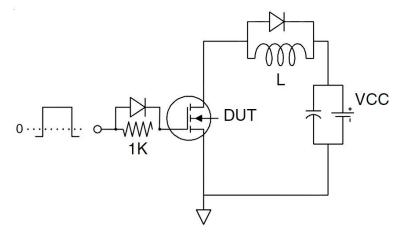
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- $\textbf{5.} \text{EAS condition}: Tj = 25\,^{\circ}\text{C}\,, V_{DD} = 50 \text{V}, V_{G} = 10 \text{V}, L = 0.5 \text{mH}, Rg = 25$

Test Circuit

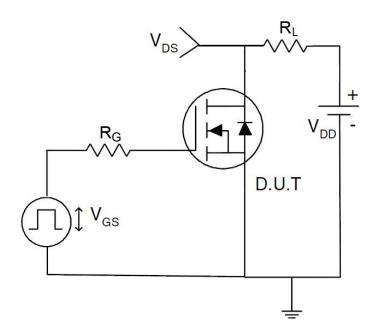
1) Eas test circuit



2) Gate charge test circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

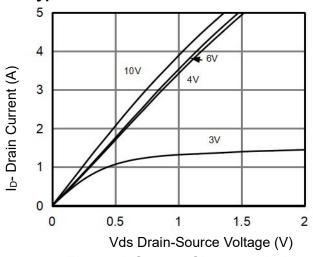


Figure 1 Output Characteristics

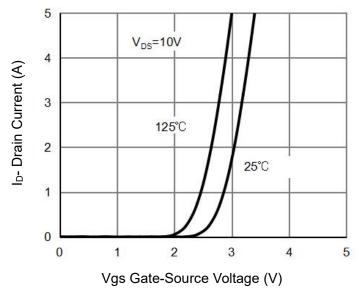


Figure 2 Transfer Characteristics

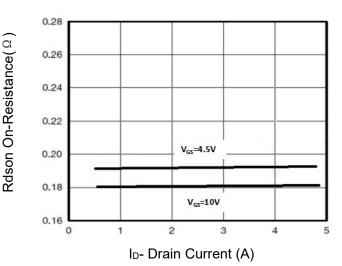


Figure 3 Rdson- Drain Current

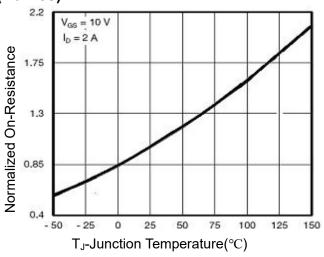


Figure 4 Rdson-JunctionTemperature

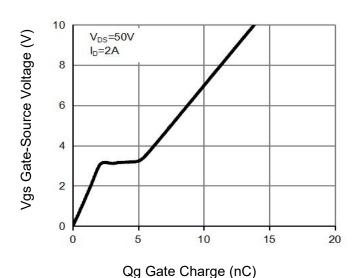


Figure 5 Gate Charge

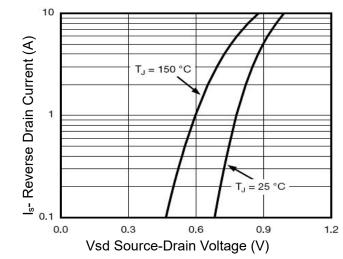


Figure 6 Source- Drain Diode Forward



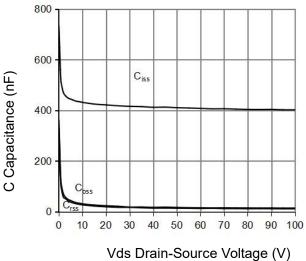


Figure 7 Capacitance vs Vds

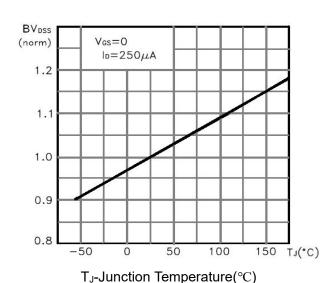
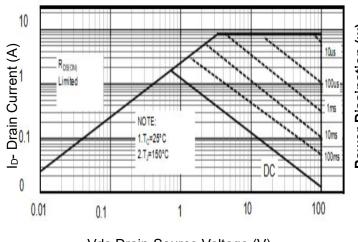


Figure 9 BV_{DSS} vs Junction Temperature



Vds Drain-Source Voltage (V)

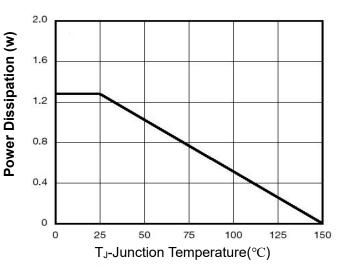
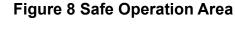


Figure 10 Power De-rati



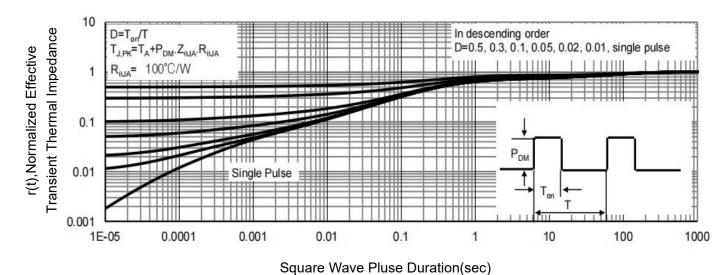
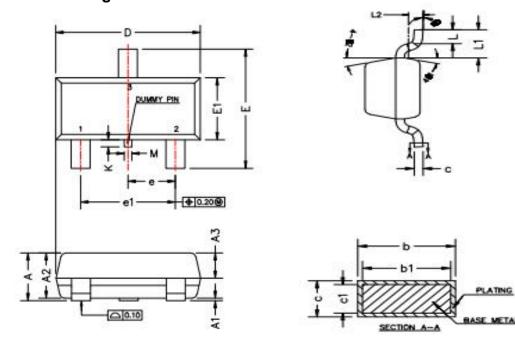


Figure 11 Normalized Maximum Transient Thermal Impedance

SOT-23 Package Information



0	Millimeters		
Symbol	Min.	Max.	
Α	0.89	1.12	
A1	0.01	0.10	
A2	0.88	1.02	
A3	0.43	0.63	
b	0.36	0.50	
b1	0.35 0.		
С	0.14	0.20	
c1	0.14	0.16	
D	2.80	3.00	
E	2.35	2.64	
E1	1.20	1.40	
е	0.90	1.00	
e1	1.80	2.00	
L	0.40	0.60	
L1	0.6REF		
L2	0.25BSC		
М	0.10 0.2		
K	0.00 0.2		
θ	0° 8°		
θ1	10°	14°	
θ2	10°	14°	

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